

# Absolute Maximum Ratings - NPN Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <pin: (1)="" (6)="" to=""></pin:>	V <sub>CC</sub>	50	V
Input Voltage <pin: (1)="" (2)="" to=""></pin:>	V <sub>IN</sub>	-6 to +40	V
Output Current	Io	70	mA
Output Current	I <sub>C</sub> (Max)	100	mA

#### Absolute Maximum Ratings - PNP Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <pin: (3)="" (4)="" to=""></pin:>	V <sub>CC</sub>	-50	V
Input Voltage <pin: (4)="" (5)="" to=""></pin:>	V <sub>IN</sub>	+6 to -40	V
Output Current	lo	-70	mA
Output Current	I <sub>C</sub> (Max)	-100	mA

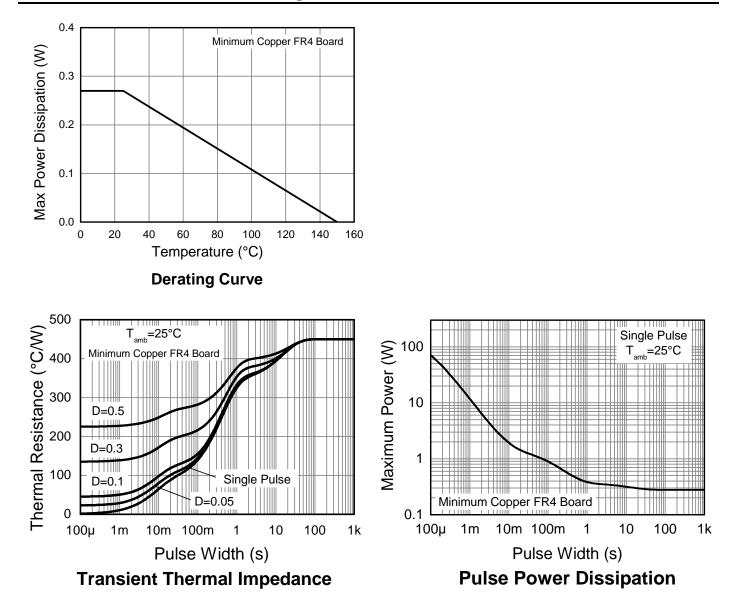
## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 6 & 7)	PD	270	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ heta JA}$	450	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-55 to +150	°C

Notes: 6. Mounted on FR4 PC Board with minimum recommended pad layout. 7. 150mW per element must not be exceeded.



### Thermal Characteristics and Derating Information





#### **Electrical Characteristics - NPN Section** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	V <sub>I(OFF)</sub>	0.3	_		V	$V_{CC} = 5V, I_{O} = 100\mu A$
Input Voltage	V <sub>I(ON)</sub>	_	_	1.4	v	$V_0 = 0.3V, I_0 = 1mA$
Output Voltage	V <sub>O(ON)</sub>	—	0.1	0.3	V	$I_0/I_1 = 5mA / 0.25mA$
Input Current	li li	_		0.88	mA	$V_I = 5V$
Output Current	I <sub>O(OFF)</sub>	_	_	0.5	μA	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain (Note 8)	GI	80		_	_	$V_0 = 5V, I_0 = 10mA$
Input Resistor (R1) Tolerance	$\Delta R_1$	-30	_	+30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	_	+20	%	—
Gain-Bandwidth Product	fT		250	_	MHz	V <sub>CE</sub> = 10V, I <sub>E</sub> = 5mA, f = 100MHz

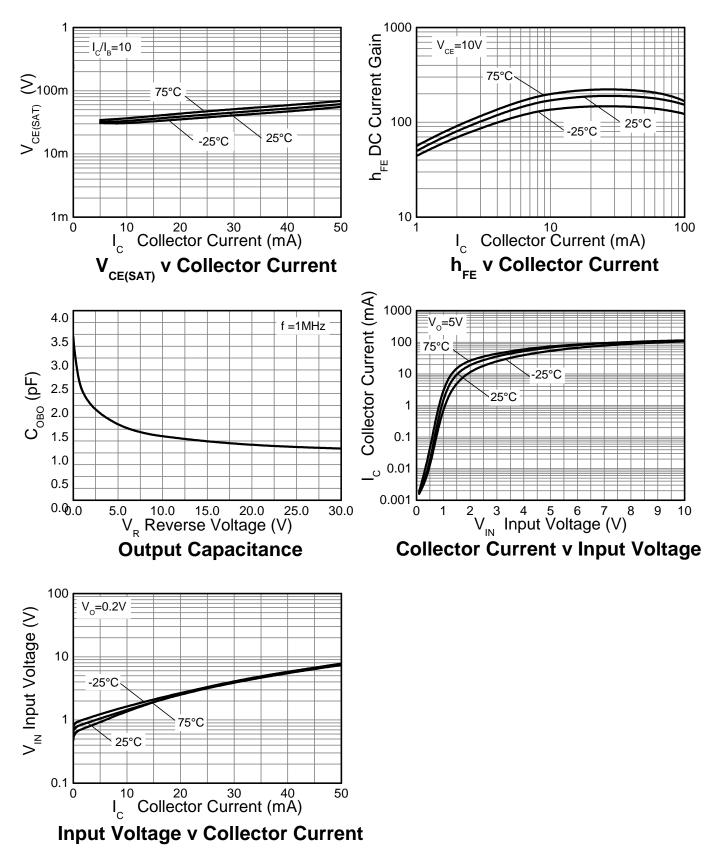
#### Electrical Characteristics - PNP Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	VI(OFF)	-0.3		—	V	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100µA
Input Voltage	V <sub>I(ON)</sub>	_		-1.4	v	$V_0 = -0.3V, I_0 = -1mA$
Output Voltage	V <sub>O(ON)</sub>	—	-0.1	-0.3	V	I <sub>O</sub> /I <sub>I</sub> = -5mA / -0.25mA
Input Current	lı lı	_		-0.88	mA	$V_{I} = -5V$
Output Current	IO(OFF)		_	-0.5	μA	$V_{CC} = -50V, V_{I} = 0V$
DC Current Gain (Note 8)	GI	80			_	$V_0 = -5V, I_0 = -10mA$
Input Resistor (R <sub>1</sub> ) Tolerance	$\Delta R_1$	-30		+30	%	_
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	_	+20	%	—
Gain-Bandwidth Product	f⊤		250		MHz	$V_{CE} = -10V$ , $I_E = -5mA$ , $f = 100MHz$

Note: 8. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



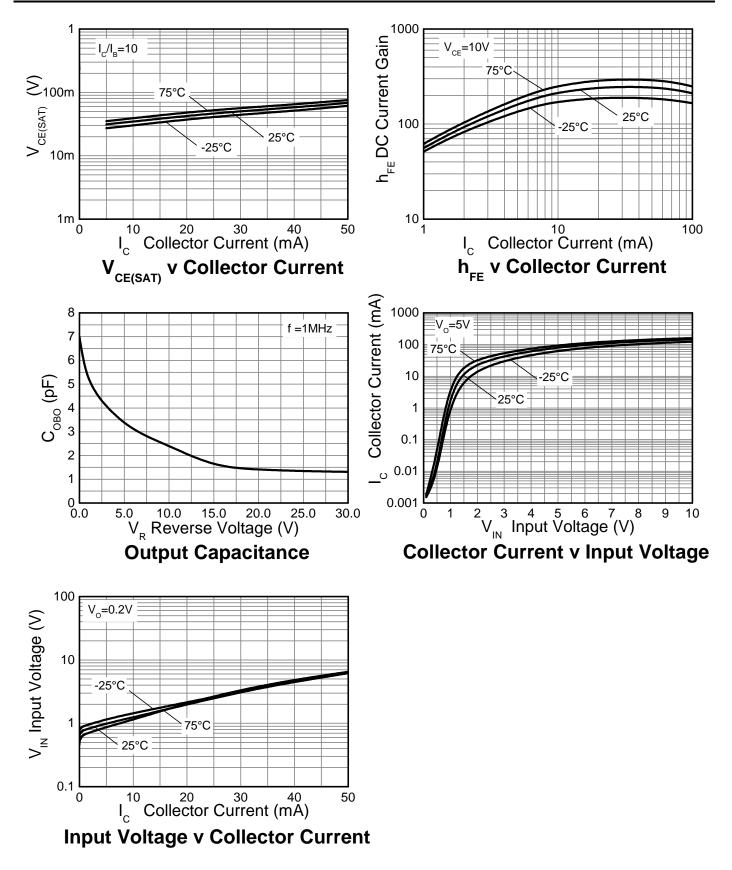
#### Typical Electrical Characteristics – NPN Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)



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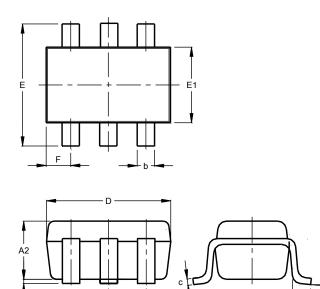
### Typical Electrical Characteristics – PNP Section (@T<sub>A</sub> = +25°C, unless otherwise specified.)





#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

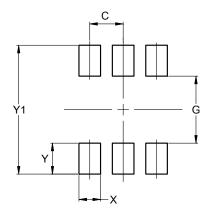


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
E	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All	All Dimensions in mm					

### Suggested Pad Layout

A1

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.420		
Y	0.600		
Y1	2.500		



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